Unit: mm

TOSHIBA Field Effect Transistor Silicon P-Channel MOS Type (π-MOSV)

2SJ439

DC/DC Converter, Relay Drive and Motor Drive Applications

• 2.5-V gate drive

• Low drain-source ON-resistance : $R_{DS(ON)} = 0.18 \Omega \text{ (typ.)}$

• High forward transfer admittance : $|Y_{fs}| = 6.0 \text{ S (typ.)}$

• Low leakage current : I_{DSS} = -100 μA (max) (V_{DS} = -16 V)

• Enhancement mode : $V_{th} = -0.5$ to -1.1 V ($V_{DS} = -10$ V, $I_{D} = -1$ mA).

Absolute Maximum Ratings (Ta = 25°C)

Characte	ristic	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	-16	y
Drain-gate voltage (R _{GS} = 20 kΩ)		V_{DGR}	716	> V
Gate-source voltage		V _{GSS}	±8	V
Drain current	DC (Note 1)	ΙD	-5	۸
	Pulse(Note 1)	I _{DP}	-20	
Drain power dissipation (Tc = 25°C)		PD	20	<\w
Channel temperature		T _{ch} (150	°C/
Storage temperature range		Tstg	-55 to 150	°C

Note 1: Ensure that the channel temperature does not exceed 150°C

 $.5\pm0.2$ 0.6 MA 5.5 ± 0.2 $.1 \pm 0.2$ 0.8 MAX 0.6 MAX 0.6 ± 0.15 2.3 ± 0,15 2.3 ± 0.15 GATE DRAIN (HEAT SINK) SOURSE **JEDEC JEITA** TOSHIBA 2-7J1B

Weight: 0.36 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristic Symbol	Max	Unit
Thermal resistance, channel to case Rth (ch-c)	6.25	°C / W
Thermal resistance, channel to ambient R _{th (ch-a)}	125	°C/W

This transistor is an electrostatic-sensitive device. Handle with care.

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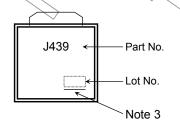
Electrical Characteristics (Ta = 25°C)

Chara	cteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	urrent	I _{GSS}	V _{GS} = ±6.5 V, V _{DS} = 0 V	_	_	±10	μΑ
Drain cutoff curr	ent	I _{DSS}	V _{DS} = -16 V, V _{GS} = 0 V	_	_	-100	μΑ
Drain-source bro	eakdown voltage	V (BR) DSS	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-16	_	_	V
Gate threshold	voltage	V _{th}	V _{DS} = -10 V, I _D = -1 mA	-0.5	_	-1.1	V
Drain-source ON-resistance		D	V _{GS} = -2.5 V, I _D = -2.5 A	(F)0.18	0.28	Ω
		R _{DS} (ON)	V _{GS} = -4 V, I _D = -2.5 A	\nearrow	0.14	0.2	7 12
Forward transfe	r admittance	Y _{fs}	V _{DS} = -10 V, I _D = -2.5 A	3.0	6.0	_	S
Input capacitano	ce	C _{iss}		_	1050	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = −10 V, V _{GS} = 0 V, f = 1 MHz	_	120	_	pF
Output capacita	nce	Coss		_	460	_	
Switching time	Rise time	t _r	VGS OV I ID = 2.5A VOUT	- (80	\ \ \	
	Turn-on time	t _{on}	-5V Rt =		100) –	
	Fall time	t _f	$V_{DD} = -8V$	7	250	_	ns
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_{\rm W} = 10 \mu \rm s$		550	_	
Total gate charg (Gate-source pl		Qg		_	24	_	
Gate-source cha	arge	Q _{gs}	$V_{DD} \approx -16 \text{ V}, V_{GS} = -5 \text{ V}, I_D = -5 \text{ A}$	_	16	_	nC
Gate-drain ("Mil	ler") charge	Q _{gd}		_	8	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

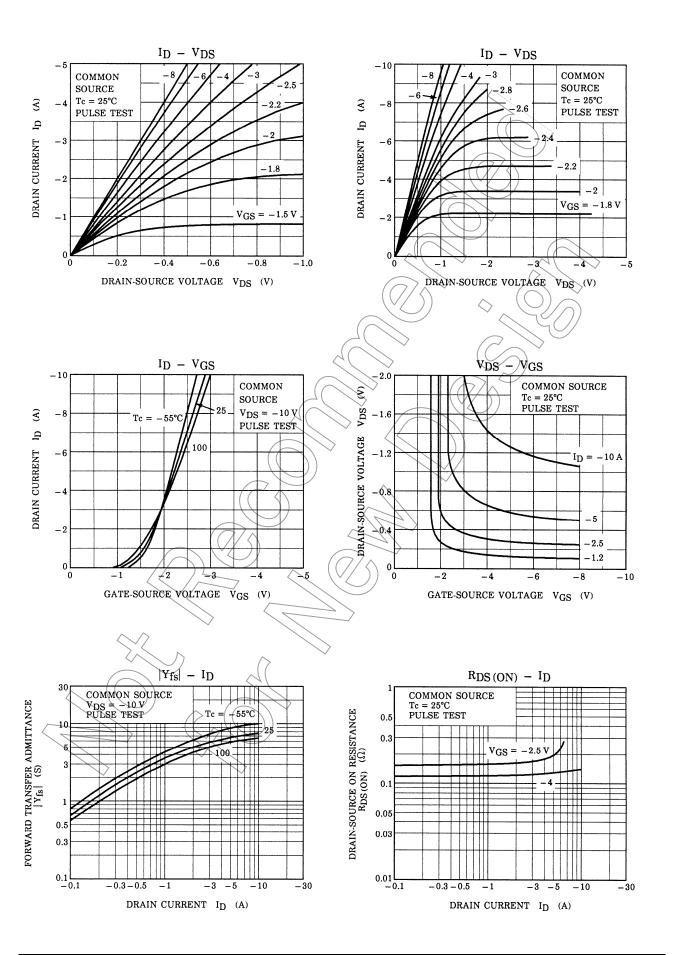
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	HDR		1	_	-5	Α
Pulse drain reverse current (Note 1)	IDRP	_	-	_	-20	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = -5 A, V _{GS} = 0 V	_	_	1.7	V
Reverse recovery time	t _{rr}	I _{DR} = -5 A, V _{GS} = 0 V,dI _{DR} / dt = 50 A / μs	_	120	_	ns
Reverse recovery charge	Qrr	1DR = -3 A, VGS = 0 V,αDR / αt = 30 A / μs	1	0.12	_	μC

Marking

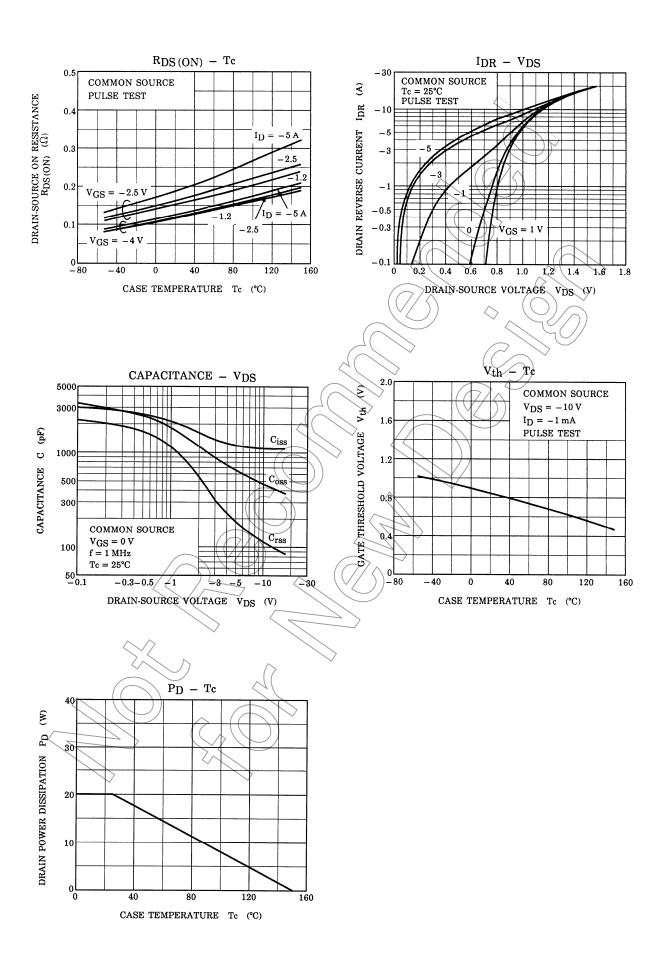


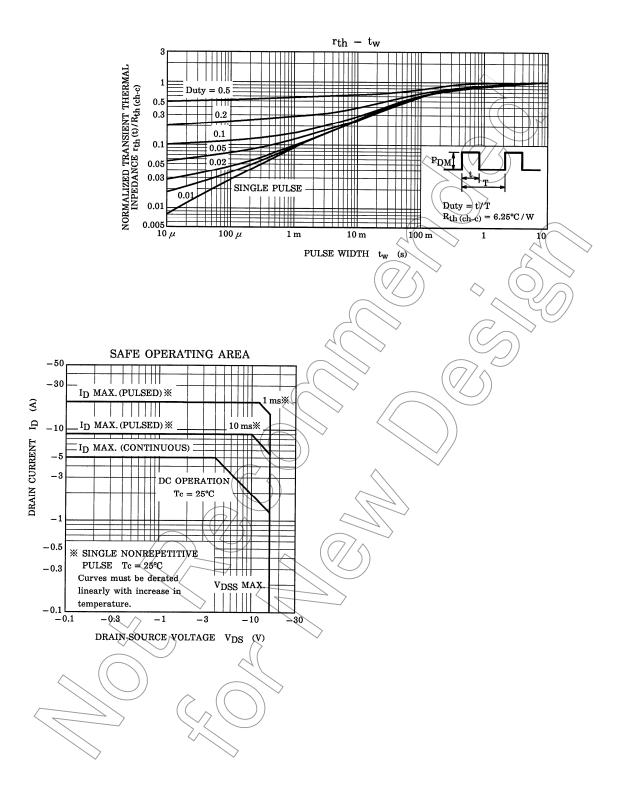
Note 3 : A line under a Lot No. identifies the indication of product Labels [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.



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